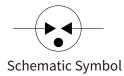


FEATURES

Surface Mounting Design 4.5*3.2*2.7mm

- High Current Handling Capability 2000A @ 8/20 μs
- Low Capacitance and Insertion Loss
- Quick Response and Long Service Life
- Moisture sensitivity level:Level 1





APPLICATION INFORMATION

Communication equipment.

- Repeaters, Modems
- | Telephone Interface,Line cards.

Data communication equipment.

AGENCY APPROVALS

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
P	Mean lead free		
IR.	UL Certificated E505857		

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



ELECTRICAL PARAMETER

Parameter	Condition	Rating	Unit
DC Blocking Voltage 1)	100V/s	480-720	V
	At 1kV/µs	for 99 % of measured values \leqslant 1300	V
Impulse Spark-over Voltage	At 1kV/µs	Typical values of distribution \leq 1200	V
Impulse Discharge Current 2)	8/20µs	2000	А
Insulation Resistance	DC=50V	≥1	GΩ
Capacitance at 1MHz	V _{DC} =0.5V	≤ 1.0	pF
Operating And Storage Temperature		-40-125	°C

1) In ionized mode

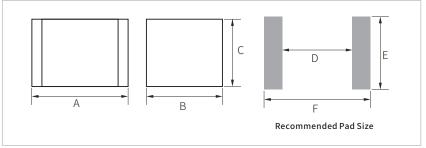
2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-311

ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards	
High Temperature Storage Test	Temperature: 85°C ; Time:2H	
Low Temperature Storage Test	Temperature: -40°C; Time:2H	
Vibration	Frequency: 10-500Hz ; Amplitude:0.15mm ; Time:45min	
Resistance of soldering heat Temperature: 260±5°C; Time of dip soldering:10s, 1time		

NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref.	mm	
A	4.5±0.3mm	
В	3.2±0.3mm	
С	2.7±0.3mm	
D	2.8mm	
E	4.0mm	
F	5.2mm	



SOLDERABILITY TEST

Solderability		
Solder Pot Temperature	Solder Dwell Time	
245°C ± 5°C	4-6 seconds	

REFLOW PROFILE

	Reflow Condition	Lead-free assembly
	Temperature Min	150°C
Pre Heat	Temperature Max	200°C
	Time(min to max)	60 – 180 secs
Average ra	mp up rate (Liquidus)Temp (T _L) to peak	3°C/second max
	$T_{s(max)}$ to T_{L} - Ramp-up Rate	5 0/30001011100
	Temperature (T _L) (Liquidus)	217°C
Reflow	Time(min to max)(t _s)	60 – 150 seconds
Peak Terr	nperature (T _P)	260 °C
Time with	nin 5°C of actual peak Temperature (tp)	20-40 seconds
Ramp-do	own Rate	6°C/second max
Time 25°	C to peak Temperature (T _P)	8 minutes max.
Do not ex	ceed	260°C

ORDERING INFORMATION

Part Number	Size	QTY/Reel	Reel Size
SG4532B600	4.5*3.2*2.7mm	2500PCS	13"



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By QR Code





Website

Wechat

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